

PCS3P2537A

Low Power Peak EMI Reduction IC

Features

rev 0.2

- 1x Peak EMI Reduction IC
- Input Frequency: 18MHz-36MHz
- Output Frequency: 18MHz-36MHz
- Frequency Deviation @ 27MHz : -0.25%
- Modulation Rate @ 27MHz : 30.1KHz
- Supply Voltage: 3.3V±0.3V
- Operating current less than 8mA @ 27MHz.
- Spread Spectrum Enable Control.
- Low power CMOS design.
- 8 pin TDFN (2X2) COL package.
- Commercial temperature

Product Description

PCS3P2537A is a versatile Low Power, 1x spread spectrum frequency modulator designed to reduce electromagnetic interference (EMI) at the clock source, allowing system wide reduction of EMI of down stream clock and data dependent signals. The device allows significant system cost savings by reducing the number of circuit board layers ferrite beads, shielding and other passive components that are traditionally required to pass EMI regulations.

PCS3P2537A modulates the output of a single PLL in order to "spread" the bandwidth of a synthesized clock, and more importantly, decreases the peak amplitudes of its harmonics. This results in significantly lower system EMI compared to the typical narrow band signal produced by oscillators and most frequency generators. Lowering EMI by increasing a signal's bandwidth is called 'spread spectrum clock generation'.

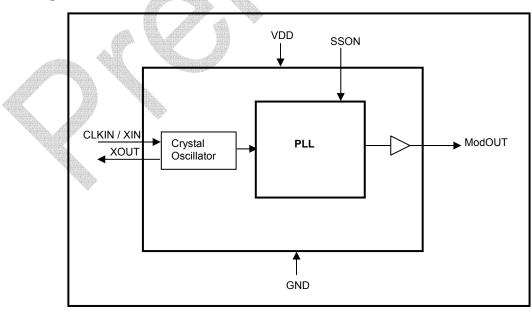
PCS3P2537A has a frequency range of 18MHz-36MHz, and accepts input clock either from a Crystal or from an external reference and locks on to it delivering a 1x spread spectrum clock output. It has an SSON control for enabling and disabling Spread Spectrum function.

PCS3P2537A operates with a supply voltage of 3.3V, and is available in 8L TDFN(2X2) COL package over commercial temperature.

Application

PCS3P2537A is targeted towards PC peripheral devices and embedded systems.

Block Diagram



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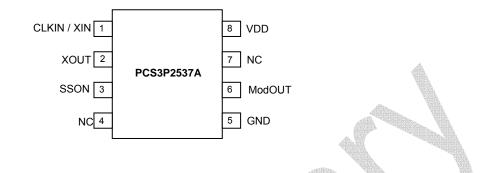
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rev 0.2

Pin Configuration (8-pin TDFN Package)



Pin Description

Pin#	Pin Name	Туре	Description
1	CLKIN / XIN	I	External reference Clock input or Crystal connection. This pin has dual functions. It can be connected either to an external crystal or an external reference clock.
2	XOUT	0	Crystal connection. If using an external reference, this pin must be left unconnected.
3	SSON	Ι	When SSON is HIGH, the spread spectrum is enabled and when LOW, it turns off the spread spectrum.
4	NC		No Connect
5	GND	Р	Ground connection.
6	ModOUT	0	Spread Spectrum Clock Output.
7	NC		No Connect
8	VDD	Р	Power supply for the entire chip



rev 0.2

Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit		
VDD, V _{IN}	Voltage on any pin with respect to Ground	-0.5 to +4.6	V		
T _{STG}	Storage temperature	-65 to +125	°C		
T _A	Operating temperature	-40 to +85	°C		
Ts	Max. Soldering Temperature (10 sec)	260	°C		
TJ	Junction Temperature	150	°C		
T _{DV}	Static Discharge Voltage (As per JEDEC STD22- A114-B)	2	KV		
Note: These are stress ratings only and are not implied for functional use. Exposure to absolute maximum ratings for prolonged periods of time may affect device reliability.					

DC Electrical Characteristics for 3.3V Supply

Symbol	Parameter	Min	Тур	Max	Unit
VIL	Input low voltage	VSS - 0.3		0.8	V
VIH	Input high voltage	2.0	WEATHER	VDD + 0.3	V
IIL	Input low current		>	-35	μA
IIн	Input high current		gr	35	μA
V _{OL}	Output low voltage (VDD = 3.3V, I _{OL} = 8mA)			0.4	V
V _{OH}	Output high voltage (VDD = 3.3V, I _{OH} = 8mA)	2.5			V
I _{DD}	Static supply current*			2.5	mA
Icc	Dynamic supply current (3.3V, 27MHz and no load)		7		mA
VDD	Operating Voltage	3	3.3	3.6	V
t _{on}	Power-up time (first locked cycle after power-up)			5	mS
Zout	Output impedance		36		Ω
CLKIN is pulle	ed to GND				

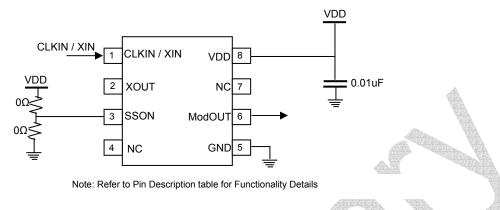
AC Electrical Characteristics for 3.3V Supply

Symbol	Parameter	Min	Тур	Max	Unit	
CLKIN	Input frequency	18	27	36	MHz	
ModOUT	Output frequency	18	27	36	MHz	
f _d	Frequency Deviation @ 27MHz	-0.2	-0.25	-0.3	%	
MR	Modulation Rate @ 27MHz	30		33	KHz	
t _{LH} *	Output rise time (measured from 20% to 80%)			2	nS	
t _{HL} *	Output fall time (measured at 80% to 20%)			1.5	nS	
t _{JC}	Jitter (cycle to cycle)			200	pS	
t _D	Output duty cycle	45	50	55	%	
*t _{LH} and t _{HL} are measured into a capacitive load of 15pF						



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Typical Application Schematic

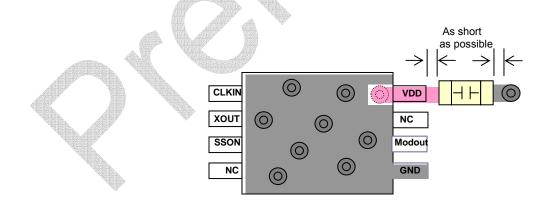


PCB Layout Recommendation

For optimum device performance, following guidelines are recommended.

- Dedicated VDD and GND planes.
- The device must be isolated from system power supply noise. A 0.01µF decoupling capacitor should be
 mounted on the component side of the board as close to the VDD pin as possible. No vias should be
 used between the decoupling capacitor and VDD pin. The PCB trace to VDD pin and the ground via
 should be kept as short as possible. All the VDD pins should have decoupling capacitors.
- In an optimum layout all components are on the same side of the board, minimizing vias through other signal layers.

A typical layout is shown in the figure





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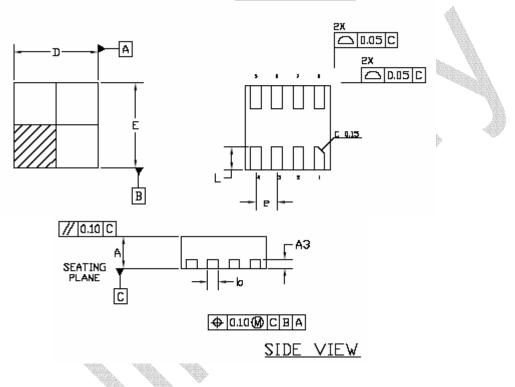
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Package Information

TDFN COL 2x2 8L package

<u>top view</u>

BOTTOM VIEW





ernernerne	Dimensions					
Symbol	Inch	nes	Millimeters			
	Min	Max	Min	Max		
A	0.027	0.0315	0.70	0.80		
A3	0.008 BSC		0.203 BSC			
b	0.008	0.012	0.20	0.30		
D	0.077	0.080	1.95	2.05		
E	0.077	0.080	1.95	2.05		
е	0.020 BSC		0.50 BSC			
L	0.020	0.024	0.50	0.60		



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rev 0.2

Ordering Codes

Part Number	Marking	Packag	Temperature	
PCS3P2537AG -08-CR AM1LL 8- pin 2-mm TDFN C			APE & REEL, Green	Commercial
LL = 2 Character LOT # Device Ordering Information P C S 3 P 2 5 3		_╋ ┙┕┙┕┙ ↑ ↑ ↑		
		0 = S = S T = T A = S V = T B = E Q = 0 DEV F = L G = 0	QFN X = SC-70 ICE PIN COUNT LEAD FREE AND RoHS COI GREEN PACKAGE	J=TSOT26 C=TDFN (2X2) COL
		X = A (- 1 = F 2 = N 3 = E 4 = []	Non PLL based7 =EMI Reduction8 =DDR support products9 =	P or n/c = Commercial 85C) (0C to +70C) Power Management Power Management Hi Performance Reserved
		Puls	eCore Semiconductor M	ixed Signal Product

Licensed under US patent #5,488,627, #6,646,463 and #5,631,920.



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Note: This product utilizes US Patent # 6,646,463 Impedance Emulator Patent issued to PulseCore Semiconductor, dated 11-11-2003 Many PulseCore Semiconductor products are protected by issued patents or by applications for patent

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